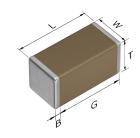
积层贴片陶瓷片式电容器

C3216X5R0J686M160AB

RoHS Reach Halogen Free Pb Free

交货型号	C3216X5R0J686MT****
用途	一般等级
特点	General 一般(~75V)
系列	C3216 [EIA 1206]
状态	量产体制



	尺寸
长度(L)	3. 20mm +0. 30, -0. 10mm
宽度(W)	1.60mm +0.30, -0.10mm
厚度(T)	1.60mm +0.30, -0.10mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	1.00mm Min.
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)
1世存/产益/印/问 (FA)	2.00mm to 2.40mm(Reflow Soldering)
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)
推存杆益印向(FD)	1.00mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)
7世代/汗血/11/円(はし)	1.10mm to 1.60mm(Reflow Soldering)

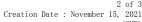
电气特性		
电容	68 μ F ±20%	
额定电压	6. 3VDC	
温度特性	$X5R(\pm 15\%)$	
耗散因数(Max.)	10%	
绝缘电阻 (Min.)	1ΜΩ	

	其他
焊接方法	流体
尸按 刀伍	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.



RoHS Reach Halogen Free Pb Free



特性图表(这是参考数据,并不保证产品的特性。)

[!] Images are for reference only and show exemplary products.

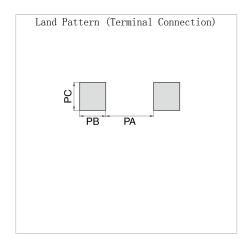
[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

C3216X5R0J686M160AB

RoHS Reach Halogen Free Pb Free

Associated Images



[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

 $^{!\ \}mbox{\em All}$ specifications are subject to change without notice.